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August 2005

FDFM2N111 Integrated N-Channel PowerTrench[®] MOSFET and Schottky Diode

FAIRCHILD

FDFM2N111

Integrated N-Channel PowerTrench® MOSFET and Schottky Diode

General Description

FDFM2N111 combines the exceptional performance of Fairchild's PowerTrench MOSFET technology with a very low forward voltage drop Schottky barrier rectifier in a MicroFET package.

This device is designed specifically as a single package solution for Standard Buck Converter. It features a fast switching, low gate charge MOSFET with very low on-state resistance.

Applications

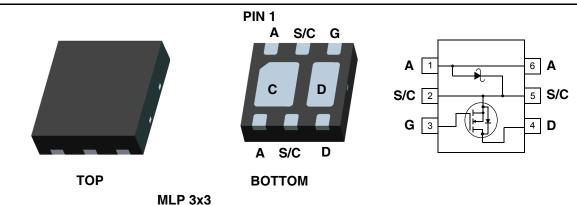
Standard Buck Converter

Features

■ 4 A, 20 V $R_{DS(ON)} = 100m\Omega @ V_{GS} = 4.5 V$

 $R_{DS(ON)} = 150 m\Omega @ V_{GS} = 2.5 V$

Low Profile - 0.8 mm maximun - in the new package MicroFET 3x3 mm



Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		20	V	
V _{GSS}	Gate-Source Voltage		±12	V	
I _D	Drain Current -Continuous	(Note 1a)	4	•	
	-Pulsed		10	— A	
V _{RRM}	Schottky Repetitive Peak Reverse voltage		20	V	
lo	Schottky Average Forward Current	(Note 1a)	2	Α	
P _D	Power dissipation (Steady State)	(Note 1a)	1.7	w	
	Power dissipation (Steady State)	(Note 1b)	0.8	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	70	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	150	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
2N111	FDFM2N111	7inch	12mm	3000 units

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Chara	cteristics						
B _{VDSS}	Drain-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		20	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{,l}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to 25°C		-	12	-	mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{D}$	_S = 16V	-	-	1	μA
I _{GSS}	Gate-Body Leakage,	$V_{GS} = \pm 12V, V_{DS} = 0V$		-	-	±100	nA
	cteristics (Note 2)						
V _{GS(TH)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D}$	_ = 250μA	0.6	1.0	1.5	V
$\frac{\Delta V_{GS(TH)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A,$ Referenced to 25°C		-	-3	-	mV/°C
41)			$I_D = 4.0A, V_{GS} = 4.5V$		54	100	
D			$I_D = 4.0$ Å, $V_{GS} = 4.5$ V $I_D = 3.3$ Å, $V_{GS} = 2.5$ V		83	150	
R _{DS(ON)}	Static Drain-Source On-Resistance		I _D = 4.0A, V _{GS} = 4.5V,		74	147	- mΩ
I _{D(ON)}	On-State Drain Current	$V_{GS} = 2.5V, V_{DS} = 5V$		10	-	-	Α
9 _{FS}	Forward Transconductance	I _D = 4A, V _{DS} =	= 5V	-	9.7	-	S
Dvnamic	Characteristics						
C _{ISS}	Input Capacitance			-	273	-	pF
C _{OSS}	Output Capacitance	──V _{DS} = 10V, V, f = 1MHz	$V_{DS} = 10V, V_{GS} = 0V,$		63	-	pF
C _{RSS}	Reverse Transfer Capacitance			-	37	-	pF
R _G	Gate Resistance	$V_{GS} = 0V, f =$	1MHz,	-	1.6	-	Ω
Switching	Given the provided and the provided of the provided and t						
t _{d(ON)}	Turn-On Delay Time			-	6	12	ns
t _r	Turn-On Rise Time	$V_{DD} = 10V, I_{D}$		-	7	14	ns
t _{d(OFF)}	Turn-Off Delay Time	V _{GS} = 4.5V, F	$R_{GEN} = 6\Omega$	-	11	20	ns
t _f	Turn-Off Fall Time			-	1.7	3.4	ns
Qg	Total Gate Charge	V _{DS} = 10V, I _D	= 4.0A	-	2.7	3.8	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5V$			0.6	-	nC
Q _{gd}	Gate-Drain Charge			-	0.9	-	nC
Drain-Soι	urce Diode Characteristics and	l Maximum R	atings				
I _S	Maximum Continuous Drain-Source Di			-	-	1.4	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0V, I_S =$	= 1.4 A (Note 2)	-	0.8	-1.2	V
t _{rr}	Diode Reverse Recovery Time	L= 4.0A. dL-/0	—I _F = 4.0A, dI _F /dt=100A/μs		11	-	ns
Q _{rr}	Diode Reverse Recovery Charge	$F = 4.0A, aF a = 100A/\mu S$		-	3	-	nC
Schottky	Diode Characteristic						
V _R	Reverse Voltage	I _R = 1mA		20	-	-	V
I _R	Reverse Leakage	V _R = 5V	T _J = 25°C T _J = 100°C	-	-	100 10	μA mA
V _F	Forward Voltage	I _F = 1A	$T_{\rm J} = 100 \rm C$ $T_{\rm J} = 25^{\circ} \rm C$	-	0.32	0.39	V
1			0				

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FDFM2N111 Integrated N-Channel PowerTrench[®] MOSFET and Schottky Diode

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Notes:

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta CA}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



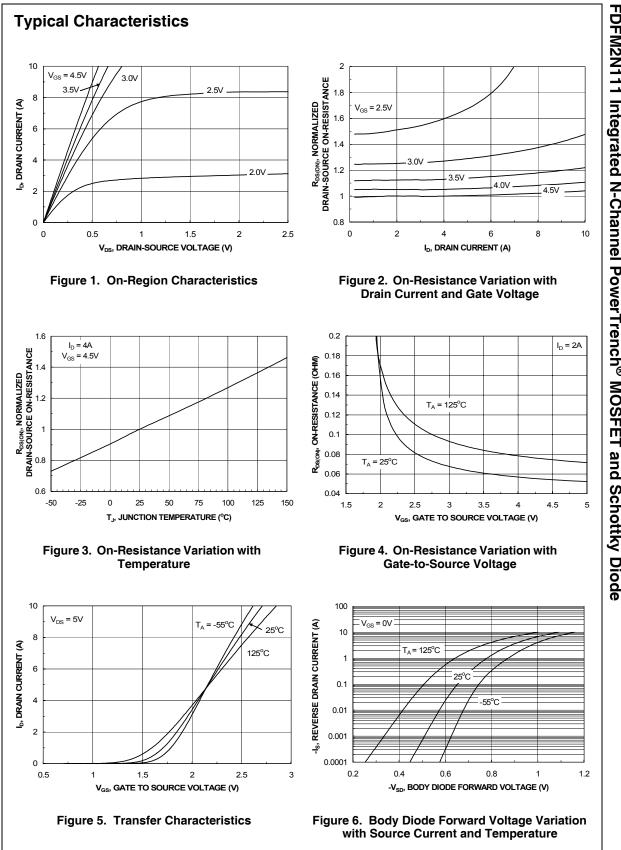
a) 70°C/W when mounted on a 1in² pad of 2 oz copper

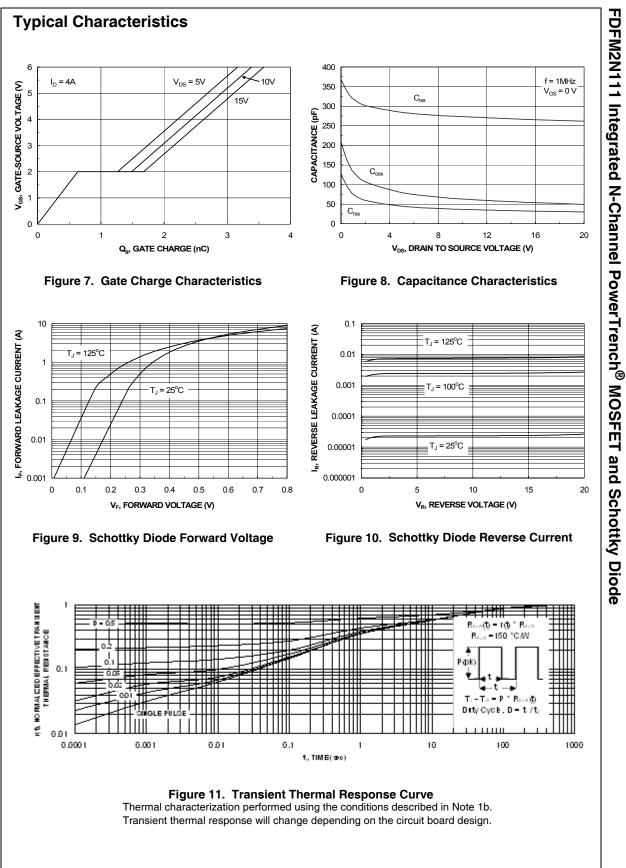
copper Scale 1: 1 c

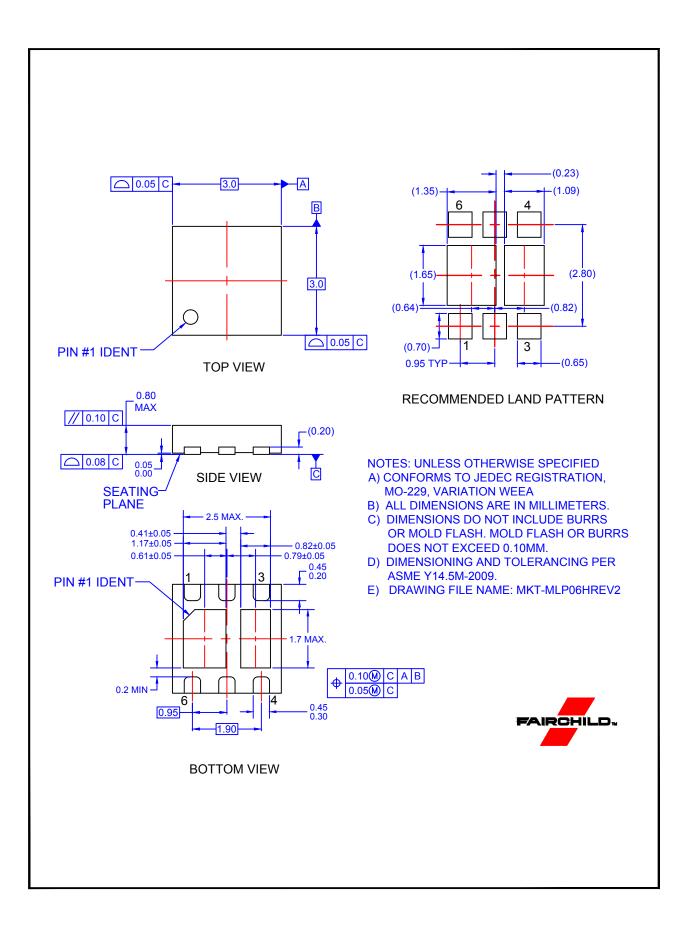
b) 150°C/W whe mounted on a minimum pad of 2 oz copper

Scale 1: 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%







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